1.2 V Dual Channel CMOS Buffer / Translator

Description

The NB3U23C is a 2-input, 2-output buffer/voltage translator for UFS (Universal Flash Storage) in portable consumer applications such as mobile phones, tablets, cameras, etc. This dual channel CMOS buffer accepts 1.8 V CMOS input and translates it to 1.2 V CMOS output. The device is powered using single supply of 1.2 V \pm 5%.

The NB3U23C is packaged in 2 ultra-small 6-pin packages: the 6 pin SC70 and a 6 pin thin UDFN package.

Features

- Operating Frequency: 52 MHz (Max)
- Propagation Delay: 5 ns (Max)
- Low Standby Current: < 10 μA at 1.2 V V_{DD}
- Low Phase Noise Floor: -150 dBc/Hz (Typ)
- Rise/Fall Times (tr/tf): 2 ns (Max)
- ESD Protection Exceeds JEDEC Standards
 - 2000 V Human–Body Model (JS–001–2012)
 - 200 V Machine Model (JESD22-A115C)
 - 1000 V Charged–Device Model (JESDC101E)
- Operating Supply Voltage Range (V_{DD}): 1.2 V ±5%
- Operating Temperature Range (Industrial): -40°C to 85°C
- These are Pb-Free Devices



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MARKING DIAGRAMS



SC-70 SQ SUFFIX CASE 419B



23C = Device Code M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.



UDFN6 MN SUFFIX CASE 517CW



C = Device Code M = Date Code

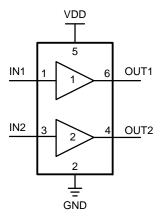


Figure 1. Simplified Logic Diagram

ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

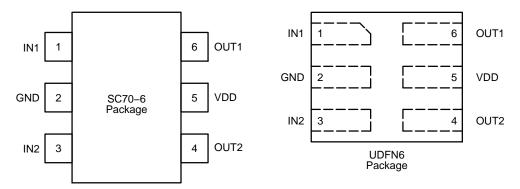


Figure 2. Pinout Diagram (Top Views)

Table 1. PIN DESCRIPTION

Number	Name	Description
1	IN1	Input Clock Signal – Channel 1
2	GND	Power Supply Ground (0 V)
3	IN2	Input Clock Signal – Channel 2
4	OUT2	Output – Channel 2
5	VDD	Power Supply Voltage
6	OUT1	Output – Channel 1

Table 2. ATTRIBUTES

Charac	Value	
ESD Protection Human Body Model Machine Model Charge Device Model		2 kV min 200 V min 1 kV min
Moisture Sensitivity (Note 1)		Level 1
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in
Transistor Count	120	
Meets or exceeds JEDEC Spe	c EIA/JESD78 IC Latchup Test II	

^{1.} For additional information, see Application Note AND8003/D.

Table 3. MAXIMUM RATINGS (Note 2)

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V_{DD}	Supply Voltage			3.6	V
V _{in}	Input Voltage			$-0.5 \le V_{ } \le 2.5$	V
Ι _D	Output Current			25	mA
T _A	Operating Temperature Range, Industrial			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm (Note 3) 0 lfpm 500 lfpm (Note 3)	SC70-6 UDFN-6	210 126 245 172	°C/W
θJC	Thermal Resistance (Junction-to-Case)	(Note 3)	SC70-6 UDFN-6	100 150	°C/W
T _{sol}	Wave Solder			260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 4. ELECTRICAL CHARACTERISTICS (VDD = $1.2 \pm 5\%$ V, GND = 0 V, $T_A = -40$ °C to +85°C)

Symbol	Characteristic	Conditions	Min	Тур	Max	Unit
DIDD	Power Supply Current (Single Channel Switching @ 52 MHz)	$C_L = 20 \text{ pF}$ $C_L = 5 \text{ pF}$ $C_L = 1 \text{ pF}$		2.5 1.5 1		mA
	Power Supply Current (Both Channels Switching @ 52 MHz)	$C_L = 20 \text{ pF}$ $C_L = 5 \text{ pF}$ $C_L = 1 \text{ pF}$		5 3 2		mA
l _{off}	Standby Current	Vi = V _{IH} Max or GND; V _{DD} = 1.2 V, No Output Load			10	μΑ
V _{IH}	Input High Voltage		0.65 * VDD		1.98	V
V_{IL}	Input Low Voltage		0		0.35 * VDD	V
V _{OH}	Output High Voltage	$C_L = 20 \text{ pF}$ $R_L = 100 \text{ k}\Omega$	0.75 * VDD		VDD	V
V _{OL}	Output Low Voltage	$C_L = 20 \text{ pF}$ $R_L = 100 \text{ k}\Omega$	0		0.25 * VDD	V
C _{in}	Input Capacitance				5	pF
F _{clk}	Operating Frequency Range		0		52	MHz
t _{PD}	Propagation Delay	INx to OUTx $C_L = 20 \text{ pF, } R_L = 100 \text{ k}\Omega$			5	ns
	Phase Noise Floor Density (Notes 4 and 5)	$C_L = 20 \text{ pF}$ $R_L = 100 \text{ k}\Omega$		-150		dBc/Hz
	Additive RMS Phase Jitter (Notes 5 and 6)	C_L = 20 pF R_L = 100 k Ω Offset Frequency Range: 50 kHz to 10 MHz		0.15	0.25	ps
DC	Output Duty Cycle (Note 7)	Input Duty Cycle = 50%, Min Input Slew Rate = 1 V/ns	45		55	%
tr/tf	Output Rise/Fall Times	$0.2 * V_{DD}$ to $0.8 * VDD$ $C_L = 20 \text{ pF}$ $R_L = 100 \text{ k}\Omega$			2	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{2.} Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and not valid simultaneously. If stress limits are exceeded device functional operation is not implied, damage may occur and reliability may be affected.

^{3.} JEDEC standard multilayer board – 2S2P (2 signal, 2 power).

^{4.} White noise floor.

^{5.} This parameter refers to the random jitter only.

^{6.} The output RMS phase jitter can be calculated using the following equation: (Output RMS Phase Jitter)² = (Input RMS Phase Jitter)² + (Additive RMS Phase Jitter)²

^{7.} Measured with input voltage swing from 0 V to 1.8 V.

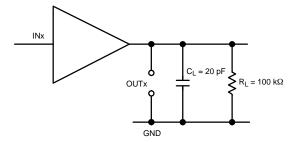


Figure 3. Typical Test Setup for Evaluation

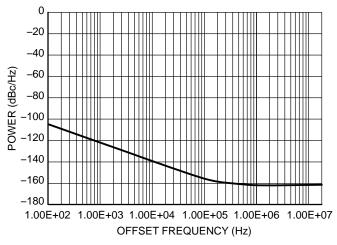


Figure 4. Typical Phase Noise Plot at 50 MHz Carrier Frequency

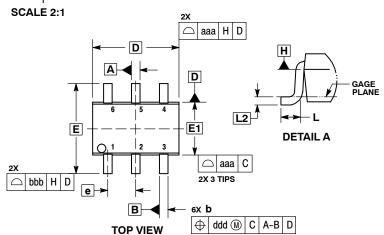
ORDERING INFORMATION

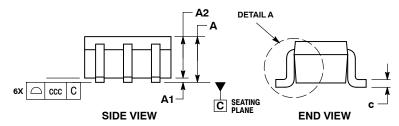
Device	Package	Shipping [†]
NB3U23CSQTCG	SC-70-6 (Pb-Free)	3000 / Tape & Reel
NB3U23CMNTAG	UDFN6 (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

SC-88/SC70-6/SOT-363 CASE 419B-02 **ISSUE Y**

DATE 11 DEC 2012





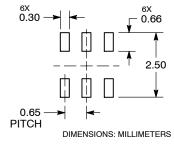
NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS
- CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H. DATUMS A AND B ARE DETERMINED AT DATUM H. DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.

- DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION 6 AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

	MIL	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α			1.10			0.043	
A1	0.00		0.10	0.000		0.004	
A2	0.70	0.90	1.00	0.027	0.035	0.039	
b	0.15	0.20	0.25	0.006	0.008	0.010	
С	0.08	0.15	0.22	0.003	0.006	0.009	
D	1.80	2.00	2.20	0.070	0.078	0.086	
E	2.00	2.10	2.20	0.078	0.082	0.086	
E1	1.15	1.25	1.35	0.045	0.049	0.053	
е		0.65 BS	С	0	.026 BS	С	
L	0.26	0.36	0.46	0.010	0.014	0.018	
L2		0.15 BS	C		0.006 BS	SC	
aaa	0.15				0.006		
bbb	0.30				0.012		
ccc		0.10			0.004		
ddd		0.10			0.004		

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code* = Pb-Free Package

(Note: Microdot may be in either location)

- *Date Code orientation and/or position may vary depending upon manufacturing location.
- *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

STYLES ON PAGE 2

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SC-88/SC70-6/SOT-363 CASE 419B-02 ISSUE Y

DATE 11 DEC 2012

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13: PIN 1. ANODE 2. N/C 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 14: PIN 1. VREF 2. GND 3. GND 4. IOUT 5. VEN 6. VCC	STYLE 15: PIN 1. ANODE 1 2. ANODE 2 3. ANODE 3 4. CATHODE 3 5. CATHODE 2 6. CATHODE 1	STYLE 16: PIN 1. BASE 1 2. EMITTER 2 3. COLLECTOR 2 4. BASE 2 5. EMITTER 1 6. COLLECTOR 1	STYLE 17: PIN 1. BASE 1 2. EMITTER 1 3. COLLECTOR 2 4. BASE 2 5. EMITTER 2 6. COLLECTOR 1	STYLE 18: PIN 1. VIN1 2. VCC 3. VOUT2 4. VIN2 5. GND 6. VOUT1
STYLE 19: PIN 1. I OUT 2. GND 3. GND 4. V CC 5. V EN 6. V REF	STYLE 20: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER 5. COLLECTOR 6. COLLECTOR	STYLE 21: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. N/C 6. CATHODE 1	STYLE 22: PIN 1. D1 (i) 2. GND 3. D2 (i) 4. D2 (c) 5. VBUS 6. D1 (c)	STYLE 23: PIN 1. Vn 2. CH1 3. Vp 4. N/C 5. CH2 6. N/C	STYLE 24: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE
STYLE 25: PIN 1. BASE 1 2. CATHODE 3. COLLECTOR 2 4. BASE 2 5. EMITTER 6. COLLECTOR 1	STYLE 26: PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2 4. SOURCE 2 5. GATE 2 6. DRAIN 1	STYLE 27: PIN 1. BASE 2 2. BASE 1 3. COLLECTOR 1 4. EMITTER 1 5. EMITTER 2 6. COLLECTOR 2	STYLE 28: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN	STYLE 29: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE/ANODE 6. CATHODE	STYLE 30: PIN 1. SOURCE 1 2. DRAIN 2 3. DRAIN 2 4. SOURCE 2 5. GATE 1 6. DRAIN 1

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

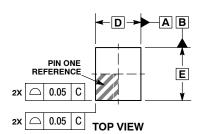
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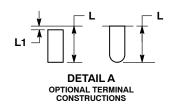
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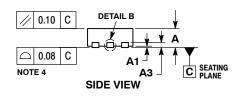


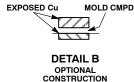
UDFN6 1.2x1.4, 0.4P CASE 517CW **ISSUE O**

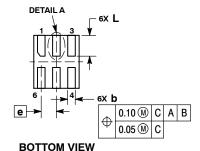
DATE 09 JAN 2014











- IOTES.

 1. DIMENSIONING AND TOLERANCING PER ASME
 Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSION 5 APPLIES TO PLATED TERMINAL AND
- IS MEASURED BETWEEN 0.15 AND 0.25MM FROM THE TERMINAL TIP.

	MILLIMETERS			
DIM	MIN	MAX		
Α	0.45	0.55		
A1	0.00	0.05		
A3	0.13 REF			
b	0.15	0.25		
D	1.20 BSC			
Е	1.40) BSC		
е	0.40 BSC			
L	0.50	0.60		
L1		0.15		

GENERIC MARKING DIAGRAM*

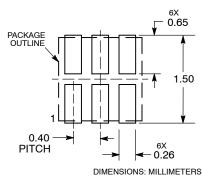


Х = Specific Device Code

= Month Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

RECOMMENDED **SOLDERING FOOTPRINT***



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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